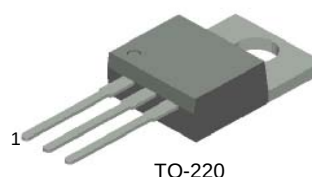


KSC5502

NPN Planar Silicon Transistor

High Voltage Power Switch Mode Application

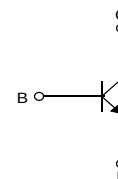
- Small Variance in Storage Time
- Wide Safe Operating Area
- Suitable for Electronic Ballast Application



TO-220

1.Base 2.Collector 3.Emitter

Equivalent Circuit



Absolute Maximum Ratings * $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
BV_{CBO}	Collector-Base Voltage	1200	V
BV_{CEO}	Collector-Emitter Voltage	600	V
BV_{EBO}	Emitter-Base Voltage	12	V
I_C	Collector Current (DC)	2	A
I_{CP}	Collector Current (Pulse)**	4	A
I_B	Base Current (DC)	1	A
I_{BP}	Collector Current (Pulse)**	2	A
P_C	Collector Dissipation($T_C=25^\circ\text{C}$)	50	W
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Junction Temperature Range	- 65 ~ 150	$^\circ\text{C}$
EAS	Avalanche Energy($T_J=25^\circ\text{C}$)	2.5	mJ

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

** Pulse Test : Pulse Width = 5ms, Duty Cycle $\leq 10\%$

Thermal Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	85	$^\circ\text{C/W}$

Ordering Information

Part Number	Marking	Package	Packing Method
KSC5502TU	J5502	TO-220	TUBE

Electrical Characteristics * $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C=1\text{mA}, I_E=0$	1200	1350		V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C=5\text{mA}, I_B=0$	600	750		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E=500\mu\text{A}, I_C=0$	12	13.2		V
I_{CES}	Collector Cut-off Current	$V_{CES}=1200\text{V}, V_{BE}=0$	$T_C=25^\circ\text{C}$		100	μA
			$T_C=125^\circ\text{C}$		500	
I_{CEO}	Collector Cut-off Current	$V_{CE}=600\text{V}, I_B=0$	$T_C=25^\circ\text{C}$		100	μA
			$T_C=125^\circ\text{C}$		500	
I_{EBO}	Emitter Cut-off Current	$V_{EB}=12\text{V}, I_C=0$	$T_C=25^\circ\text{C}$		10	μA
h_{FE}	DC Current Gain	$V_{CE}=1\text{V}, I_C=0.2\text{A}$	$T_C=25^\circ\text{C}$	15	28	40
			$T_C=125^\circ\text{C}$	8	27	
		$V_{CE}=1\text{V}, I_C=1\text{A}$	$T_C=25^\circ\text{C}$	4	8.7	
			$T_C=125^\circ\text{C}$	3	6.6	
		$V_{CE}=2.5\text{V}, I_C=0.5\text{A}$	$T_C=25^\circ\text{C}$	12	20	30
			$T_C=125^\circ\text{C}$	6	16	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=0.2\text{A}, I_B=0.02\text{A}$	$T_C=25^\circ\text{C}$	0.09	0.8	V
			$T_C=125^\circ\text{C}$	0.13	1.1	V
		$I_C=0.4\text{A}, I_B=0.08\text{A}$	$T_C=25^\circ\text{C}$	0.08	0.6	V
			$T_C=125^\circ\text{C}$	0.12	1.0	V
		$I_C=1\text{A}, I_B=0.2\text{A}$	$T_C=25^\circ\text{C}$	0.19	1.5	V
			$T_C=125^\circ\text{C}$	0.35	3.0	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C=0.4\text{A}, I_B=0.08\text{A}$	$T_C=25^\circ\text{C}$	0.77	1.0	V
			$T_C=125^\circ\text{C}$	0.65	0.9	V
		$I_C=1\text{A}, I_B=0.2\text{A}$	$T_C=25^\circ\text{C}$	0.83	1.2	V
			$T_C=125^\circ\text{C}$	0.70	1.0	V
C_{ib}	Input Capacitance	$V_{EB}=8\text{V}, I_C=0, f=1\text{MHz}$		410	500	pF
C_{ob}	Output Capacitance	$V_{CB}=10\text{V}, I_E=0, f=1\text{MHz}$		20	100	pF

* Pulse Test : Pulse Width = 5ms, Duty Cycle $\leq 10\%$

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition		Min	Typ.	Max.	Units
V _{CE} (DSAT)	Dynamic Saturation Voltage	I _C =0.4A, I _{B1} =80mA V _{CC} =300V	@ 1μs		11		V
			@ 3μs		8		V
		I _C =1A, I _{B1} =200mA V _{CC} =300V	@ 1μs		23		V
			@ 3μs		13		V
RESISTIVE LOAD SWITCHING (D.C ≤ 10%, Pulse Width=20s)							
t _{ON}	Turn On Time	I _C =0.4A, I _{B1} =80mA I _{B2} =0.2A, V _{CC} =300V R _L = 750Ω	T _C =25°C		250	350	ns
			T _C =125°C		260		ns
t _{OFF}	Turn Off Time		T _C =25°C		3.3	4.0	μs
			T _C =125°C		3.8		μs
t _{ON}	Turn On Time	I _C =1A, I _{B1} =160mA I _{B2} =160mA, V _{CC} =300V R _L = 300Ω	T _C =25°C		220	450	ns
			T _C =125°C		250		ns
t _{OFF}	Turn Off Time		T _C =25°C		4.3	5.0	μs
			T _C =125°C		5.0		μs
INDUCTIVE LOAD SWITCHING (V _{CC} =15V)							
t _{STG}	Storage Time	I _C =0.4A, I _{B1} =80mA I _{B2} =0.2A, V _Z =300V L _C =200uH	T _C =25°C		1.4	2.0	μs
			T _C =125°C		1.7		μs
t _F	Fall Time		T _C =25°C		130	200	ns
			T _C =125°C		80		ns
t _C	Cross-over Time		T _C =25°C		210	350	ns
			T _C =125°C		130		ns
t _{STG}	Storage Time	I _C =0.8A, I _{B1} =160mA I _{B2} =160mA, V _{CC} =300V L _C =200uH	T _C =25°C		4.9	5.5	μs
			T _C =125°C		5.3		μs
t _F	Fall Time		T _C =25°C		170	250	ns
			T _C =125°C		340		ns
t _C	Cross-over Time		T _C =25°C		300	600	ns
			T _C =125°C		810		ns

Typical Characteristics

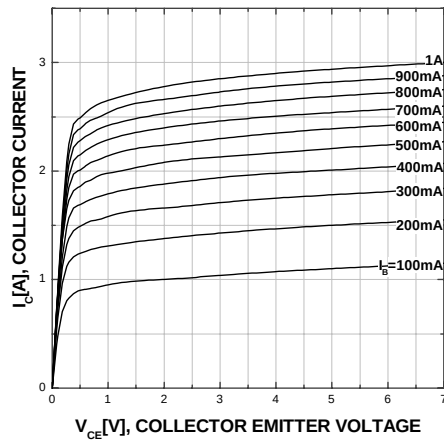


Figure 1. Static Characteristic

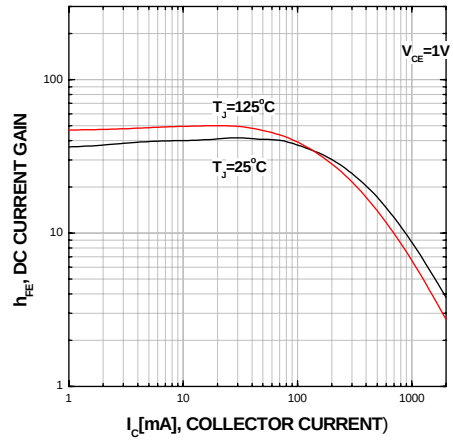


Figure 2. DC current Gain

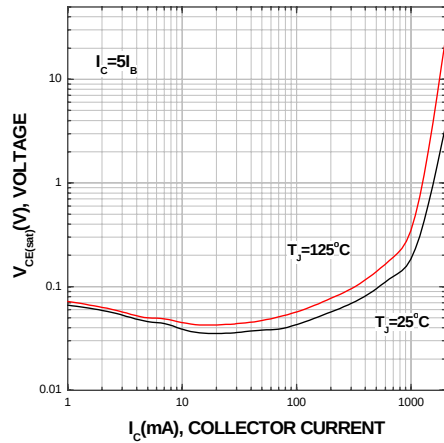


Figure 3. Collector-Emitter Saturation Voltage

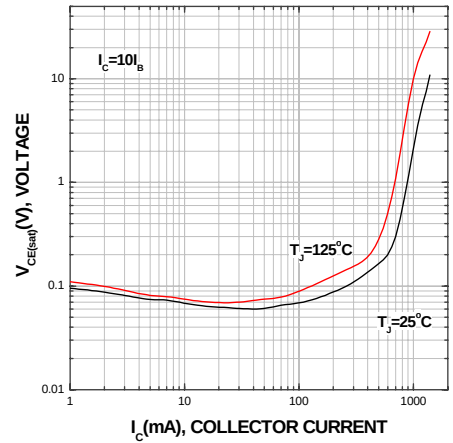


Figure 4. Collector-Emitter Saturation Voltage

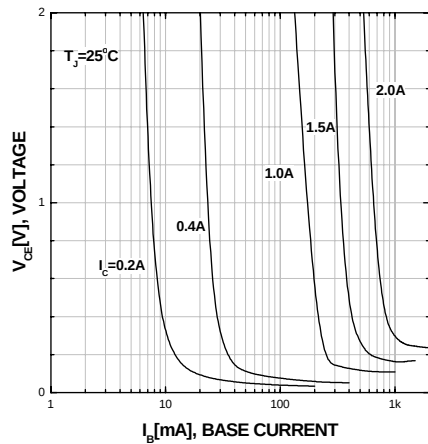


Figure 5. Typical Collector Saturation Voltage

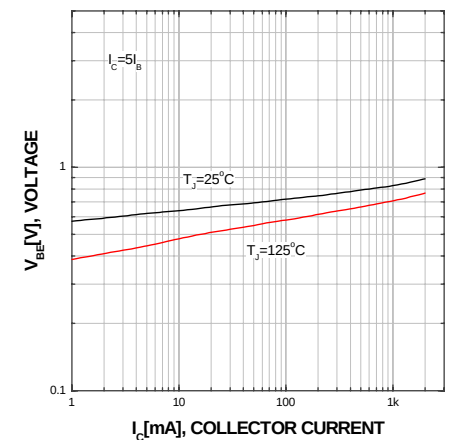


Figure 6. Base-Emitter Saturation Voltage

Typical Characteristics (Continued)

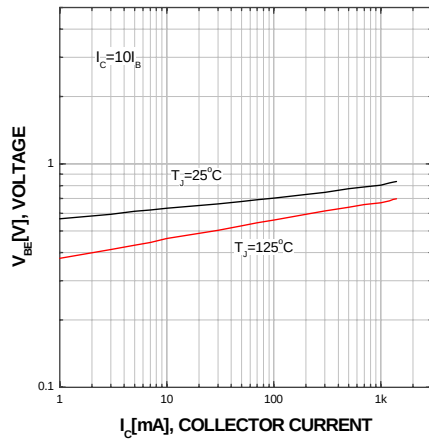


Figure 7. Base-Emitter Saturation Voltage

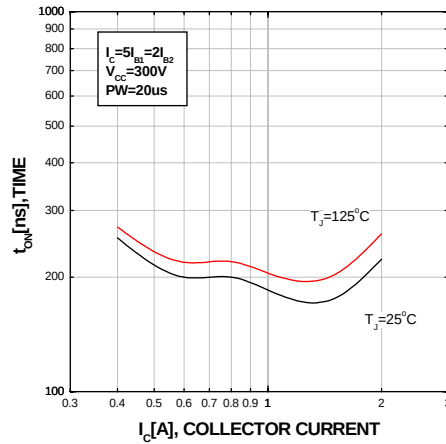


Figure 8. Resistive Switching Time, t_{on}

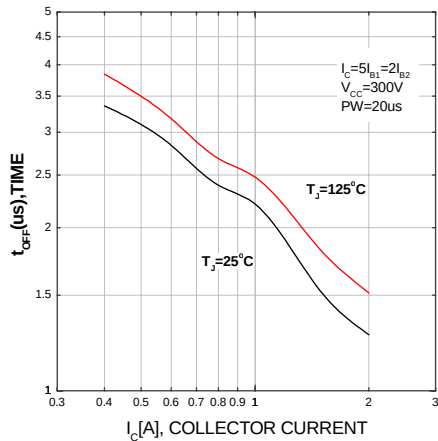


Figure 9. Resistive Switching Time, t_{off}

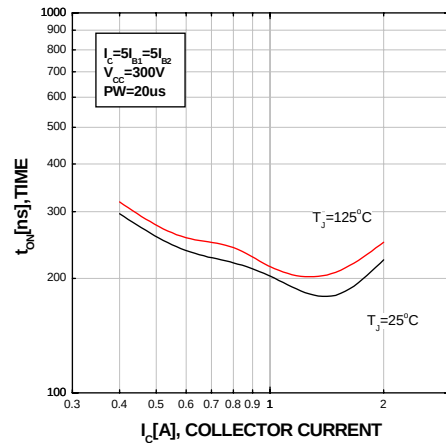


Figure 10. Resistive Switching Time, t_{on}

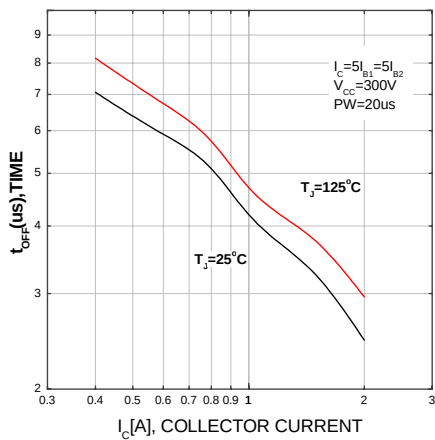


Figure 11. Resistive Switching Time, t_{off}

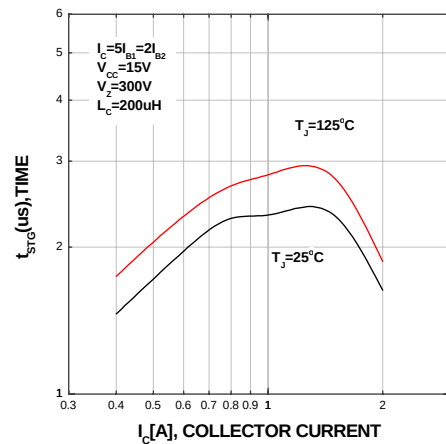


Figure 12. Inductive Switching Time, t_{STG}

Typical Characteristics (Continued)

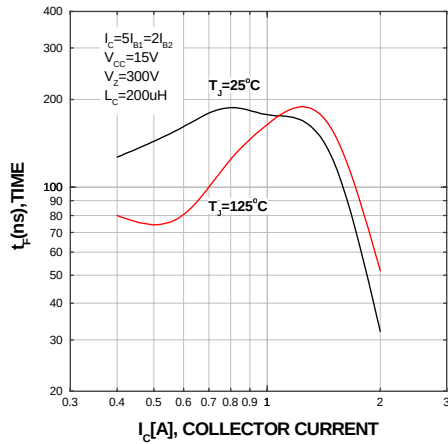


Figure 13. Inductive Switching Time, t_f

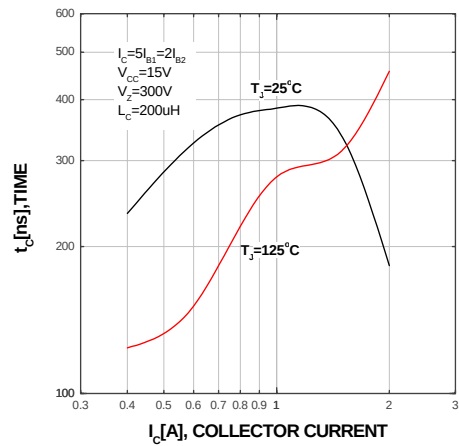


Figure 14. Inductive Switching Time, t_c

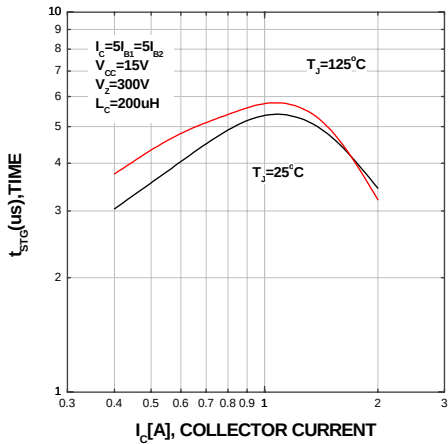


Figure 15. Inductive Switching Time, t_{STG}

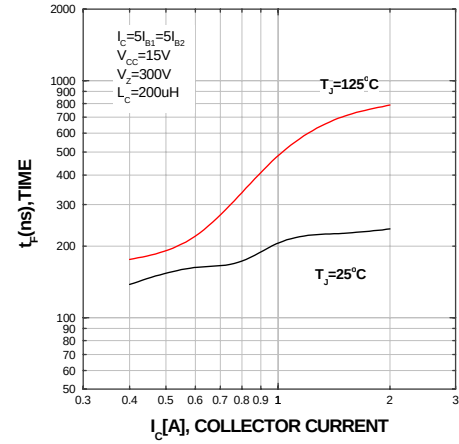


Figure 16. Inductive Switching Time, t_f

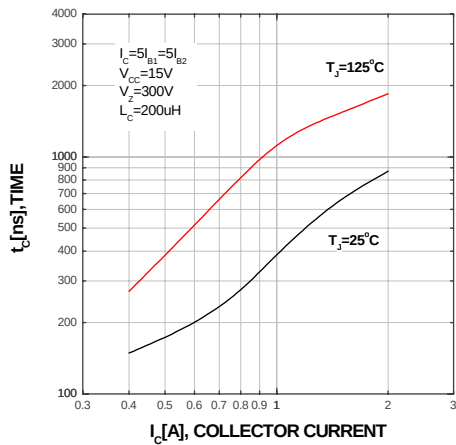


Figure 17. Inductive Switching Time, t_c

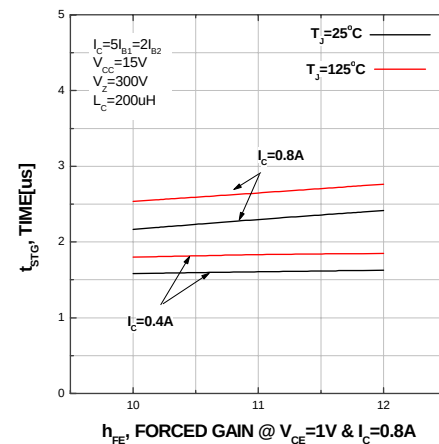


Figure 18. Inductive Switching Time, t_{STG}

Typical Characteristics (Continued)

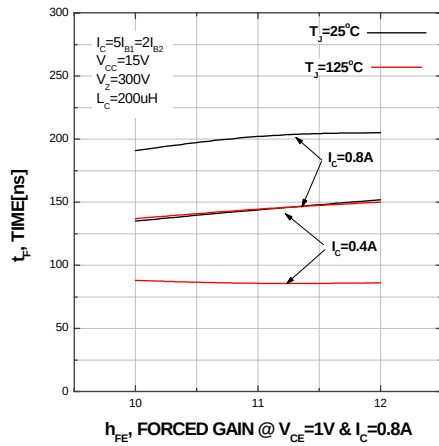


Figure 19. Inductive Switching Time, t_F

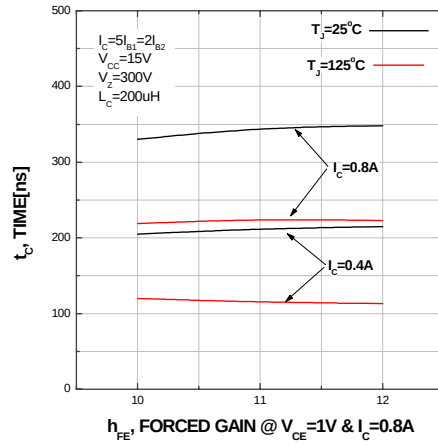


Figure 20. Inductive Switching Time, t_C

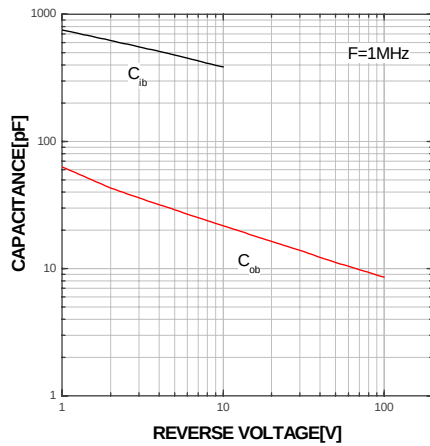


Figure 21. Capacitance

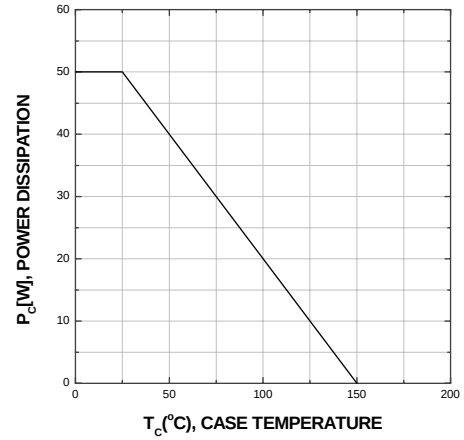


Figure 22. Power Derating



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